MA3Z792D (MA792WA), MA3Z792E (MA792WK)

Silicon epitaxial planar type

For super high speed switching For small current rectification

Features

- Two MA3Z792 (MA792) is contained in one package
- Forward current (Average) $I_{F(AV)} = 100 \text{ mA}$ rectification is possible
- Optimum for high frequency rectification because of its short reverse recovery time t_{rr}
- Low forward voltage V_F and good rectification efficiency

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter		Symbol	Rating	Unit	
Reverse voltage		V_R	30	V	
Repetitive peak reverse voltage		V _{RRM}	30	V	
Forward current	Single	I_{F}	100	mA	
	Double *1		70		
Peak forward	Single	I_{FM}	300	mA	
current	Double *1		200	i,	
Non-repetitive peak forward surge current *2		I _{FSM}	1	A	
Junction temperature		T _j	125	C C	
Storage temperature		T_{stg}	-55 to +125	°C	



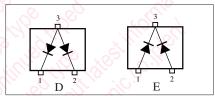
*2: The peak-to-peak value in one cycle of 50 Hz sine wave (non-repetitive)

Unit: mm 0.3201 0.3201 0.15201 0.15201 0.920

Marking Symbol

MA3Z792D: M3Y
 MA3Z792E: M3Z

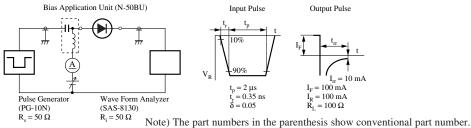
Internal Connection



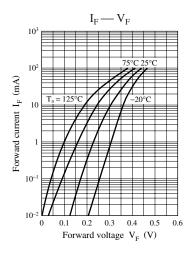
■ Electrical Characteristics $T_a = 25$ °C ± 3 °C

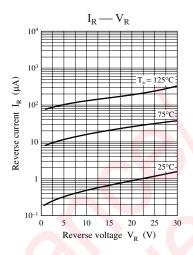
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	$V_{\rm F}$	I _F = 100 mA			0.55	V
Reverse current	I_R	$V_R = 30 \text{ V}$			15	μΑ
Terminal capacitance	C _t	$V_R = 0 \text{ V, f} = 1 \text{ MHz}$		20		pF
Reverse recovery time *	t _{rr}	$I_F = I_R = 100 \text{ mA}$		2		ns
		$I_{rr} = 10 \text{ mA}, R_L = 100 \Omega$				

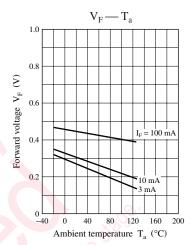
- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.
 - 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
 - 3. Absolute frequency of input and output is 250 MHz.
 - 4.*: t_{rr} measurement circuit

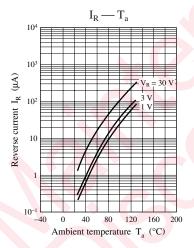


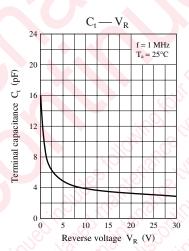
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